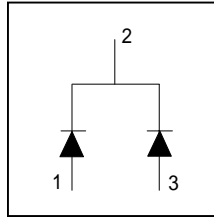


### Features

- Ultrafast Recovery
- Ultrasoft Recovery
- Very Low  $I_{RRM}$
- Very Low  $Q_{rr}$
- Specified at Operating Conditions

### Benefits

- Reduced RFI and EMI
- Reduced Power Loss in Diode and Switching Transistor
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count



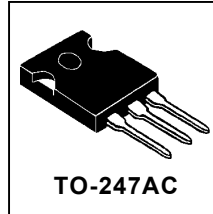
$$V_R = 600V$$

$$V_F = 1.7V$$

$$Q_{rr}^* = 65nC$$

$$di_{(rec)}/dt^* = 240A/\mu s$$

\* 125°C



### Description

International Rectifier's HFA16PA60C is a state of the art center tap ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 volts and 8 amps per Leg continuous current, the HFA16PA60C is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current ( $I_{RRM}$ ) and does not exhibit any tendency to "snap-off" during the  $t_b$  portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA16PA60C is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

### Absolute Maximum Ratings (per Leg)

	Parameter	Max	Units
$V_R$	Cathode-to-Anode Voltage	600	V
$I_F @ T_C = 100^\circ C$	Continuous Forward Current (per Leg)	8	A
$I_{FSM}$	Single Pulse Forward Current	60	
$I_{FRM}$	Maximum Repetitive Forward Current	24	
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	36	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	14	
$T_J$	Operating Junction and	-55 to +150	°C
$T_{STG}$	Storage Temperature Range		

**Electrical Characteristics (per Leg) @ T<sub>J</sub> = 25°C (unless otherwise specified)**

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
V <sub>BR</sub>	Cathode Anode Breakdown Voltage	600			V	I <sub>R</sub> = 100μA
V <sub>FM</sub>	Max Forward Voltage		1.4	1.7	V	I <sub>F</sub> = 8A
			1.7	2.1		I <sub>F</sub> = 16A
			1.4	1.7		I <sub>F</sub> = 8A, T <sub>J</sub> = 125°C
I <sub>RM</sub>	Max Reverse Leakage Current		0.3	5	μA	V <sub>R</sub> = V <sub>R</sub> Rated
			100	500		T <sub>J</sub> = 125°C, V <sub>R</sub> = 0.8 x V <sub>R</sub> Rated
C <sub>T</sub>	Junction Capacitance		10	25	pF	V <sub>R</sub> = 200V
L <sub>S</sub>	Series Inductance		8.0		nH	Measured lead to lead 5mm from package body

**Dynamic Recovery Characteristics (per Leg) @ T<sub>J</sub> = 25°C (unless otherwise specified)**

	Parameter	Min	Typ	Max	Units	Test Conditions
t <sub>rr</sub>	Reverse Recovery Time		18		ns	I <sub>F</sub> = 1.0A, di <sub>F</sub> /dt = 200A/μs, V <sub>R</sub> = 30V
t <sub>rr1</sub>	See Fig. 5, 6 & 16		37	55		T <sub>J</sub> = 25°C
t <sub>rr2</sub>			55	90		T <sub>J</sub> = 125°C
I <sub>RRM1</sub>	Peak Recovery Current		3.5	5.0	A	V <sub>R</sub> = 200V
I <sub>RRM2</sub>	See Fig. 7 & 8		4.5	8.0		
Q <sub>rr1</sub>	Reverse Recovery Charge		65	138	nC	di <sub>F</sub> /dt = 200A/μs
Q <sub>rr2</sub>	See Fig. 9 & 10		124	360		
di <sub>(rec)M</sub> /dt1	Peak Rate of Fall of Recovery Current		240		A/μs	T <sub>J</sub> = 25°C
di <sub>(rec)M</sub> /dt2	During t <sub>b</sub> See Fig. 11 & 12		210			

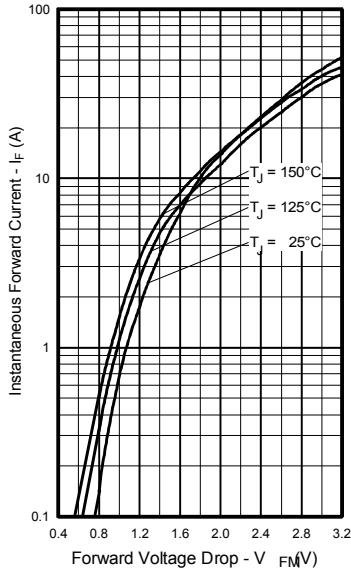
**Thermal - Mechanical Characteristics**

	Parameter	Min	Typ	Max	Units
T <sub>lead</sub> <sup>①</sup>	Lead Temperature			300	°C
R <sub>thJC</sub>	Junction-to-Case, Single Leg Conducting			3.5	K/W
	Junction-to-Case, Both Legs Conducting			1.75	
R <sub>thJA</sub> <sup>②</sup>	Thermal Resistance, Junction to Ambient			40	
R <sub>thCS</sub> <sup>③</sup>	Thermal Resistance, Case to Heat Sink		0.25		
Wt	Weight		6		g
				0.21	(oz)
	Mounting Torque		6	12	Kg-cm
			5	10	lbf-in

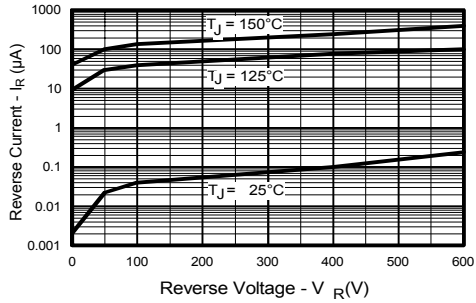
① 0.063 in. from Case (1.6mm) for 10 sec

② Typical Socket Mount

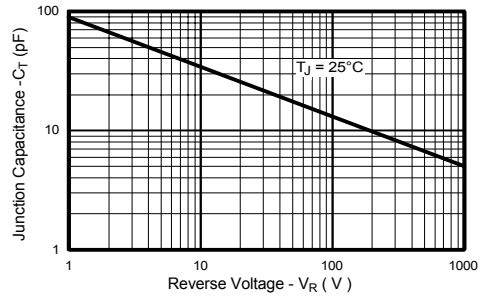
③ Mounting Surface, Flat, Smooth and Greased



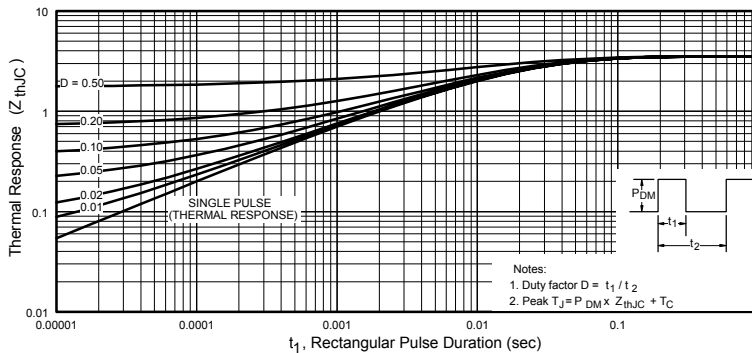
**Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current, (per Leg)**



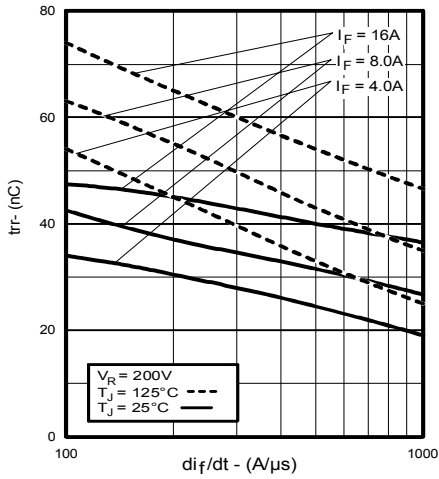
**Fig. 2 - Typical Reverse Current vs. Reverse Voltage, (per Leg)**



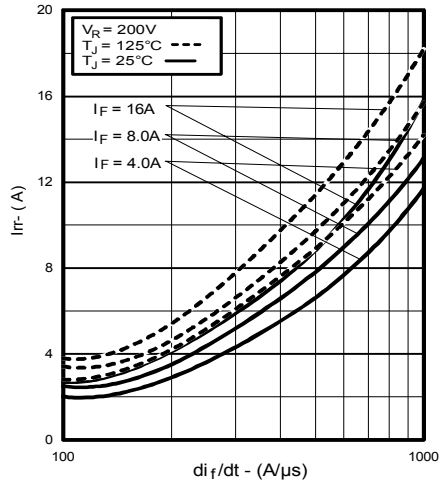
**Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, (per Leg)**



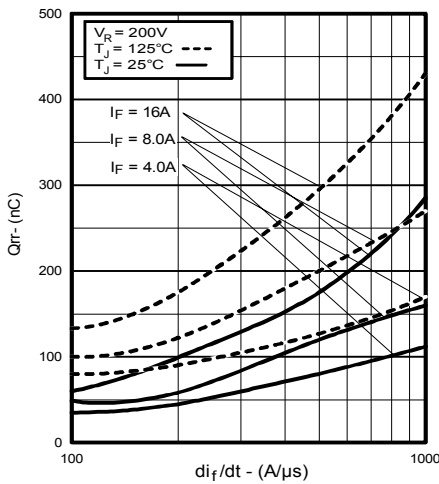
**Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics, (per Leg)**



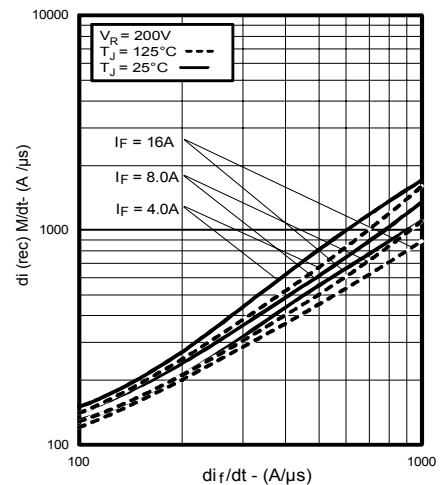
**Fig. 5** - Typical Reverse Recovery vs.  $di_f/dt$ , (per Leg)



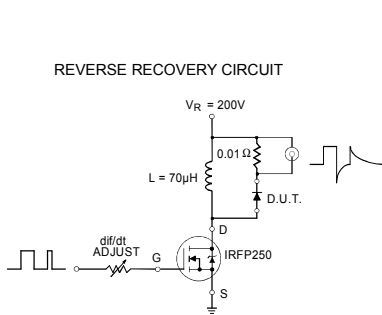
**Fig. 6** - Typical Recovery Current vs.  $di_f/dt$ , (per Leg)



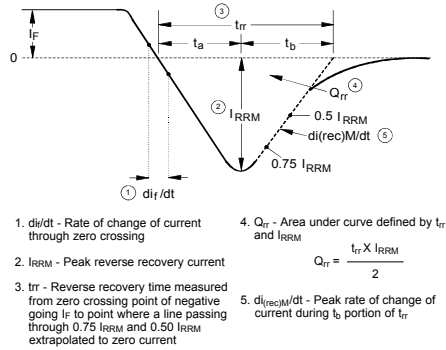
**Fig. 7** - Typical Stored Charge vs.  $di_f/dt$ , (per Leg)



**Fig. 8** - Typical  $di_{(rec)}M/dt$  vs.  $di_f/dt$ , (per Leg)



**Fig. 9 - Reverse Recovery Parameter Test Circuit**



**Fig. 10 - Reverse Recovery Waveform and Definitions**

**Ordering Information Table**

Device Code	
HF	A
16	PA
60	C
①	②
③	④
⑤	⑥
⑦	⑧
⑨	⑩
⑪	⑫
⑬	⑭
⑮	⑯
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